

Electronic Patent Application Fee Transmittal

Application Number:	10549418			
Filing Date:	14-Sep-2005			
Title of Invention:	Probe positioning and bonding device and probe bonding method			
First Named Inventor/Applicant Name:	Oug-Ki Lee			
Filer:	Steven M. Cohen/Trish McHugh			
Attorney Docket Number:	21CEN-007PUS			
Filed as Small Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	2801	1	405	405
Total in USD (\$)				405